

PREPARED BY:	DATE	SHARP	SPEC No. LD-K22712A
APPROVED BY:	DATE		FILE No.
			ISSUE: August, 24, 2010
			PAGE :23 pages
		LIQUID CRYSTAL DISPLAY GROUP SHARP CORPORATION	APPLICABLE GROUP LIQUID CRYSTAL DISPLAY GROUP

DEVICE SPECIFICATION FOR
TFT-LCD Cell

MODEL No. LK315D3HA4M

CUSTOMER'S APPROVAL

DATE

PRESENTED

BY

BY *Takayuki Shimada*

T.Shimada
General manager

LIQUID CRYSTAL DISPLAY DIVISION I
LIQUID CRYSTAL DISPLAY GROUP
SHARP CORPORATION

RECORDS OF REVISION

MODEL No. : LK315D3HA4M

SPEC No. : LD-K22712A

1 Application

This specification applies to the color 32.0" TFT-LCD Cell LK315D3HA4M.

(With parts (S-Dr, G-Dr, S-PWB, G-PWB, FPC, C-PWB, Thermally conductive interface Pad) to drive it.)

- * These specification are proprietary products of SHARP CORPORATION ("SHARP") and include materials protected under copyright of SHARP. Do not reproduce or cause any third party to reproduce them in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP.
- * In case of using the device for applications such as control and safety equipment for transportation (aircraft, trains, automobiles, etc.), rescue and security equipment and various safety related equipment which require higher reliability and safety, take into consideration that appropriate measures such as fail-safe functions and redundant system design should be taken.
- * Do not use the device for equipment that requires an extreme level of reliability, such as aerospace applications, telecommunication equipment (trunk lines), nuclear power control equipment and medical or other equipment for life support.
- * SHARP assumes no responsibility for any damage resulting from the use of the device that does not comply with the instructions and the precautions specified in these specification.
- * Contact and consult with a SHARP sales representative for any questions about this device.

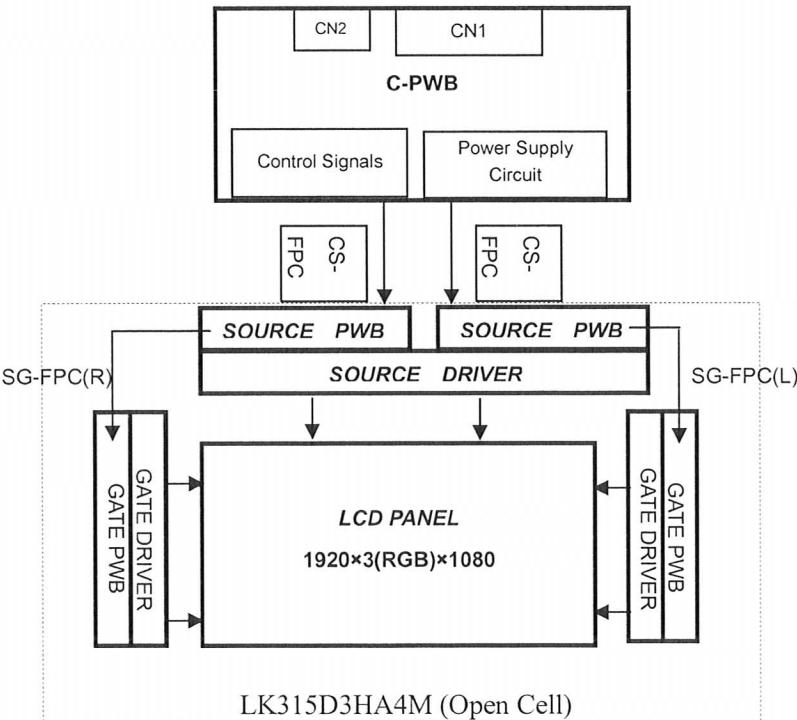
2 Overview

This Cell (LK315D3HA4M) is a color active matrix LCD PANEL incorporating amorphous silicon TFT (Thin Film Transistor), and the polarizer is contained. In addition, the Open Cell is composed of a color TFT-LCD Cell (LK315D3HA4M), Gate PWB and Source PWB. The following content can be achieved in using CONTROL-PWB "C-PWB" (RUNTK4323TPZV), CS-FPC and SG-FPC that SHARP specifies.

Graphics and texts can be displayed on a $1920 \times \text{RGB} \times 1080$ dots panel with one billion colors by using 10bit+ LVDS (Low Voltage Differential Signaling) to interface, +12V of DC supply voltages.

And in order to improve the response time of LCD, This C-PWB applies the Over Shoot driving (O/S driving) technology for the control circuit .In the O/S driving technology, signals are being applied to the Liquid Crystal according to a pre-fixed process as an image signal of the present frame when a difference is found between image signal of the previous frame and that of the current frame after comparing them.

With combination of these technologies, motion blur can be reduced and clearer display performance can be realized. Moreover, thermally conductive interface Pad and the C-PWB cover are needed for the T-CON heat radiation of C-PWB.



List of open cell and parts(▲A)

parts	parts code
Open Cell	LK315D3HA4M
C-PWB	LK0DZ1C0241
CS-FPC	LK0DZ1C0238
SG-FPC(L)	LK0DZ1C0239
SG-FPC(R)	LK0DZ1C0240

3 Mechanical Specifications

Parameter	Specifications	Unit
Display size	80.1 (Diagonal)	cm
	31.55 (Diagonal)	inch
Active area	698.4(H) x 392.85 (V)	mm
Pixel Format	1920(H) x 1080(V) (1pixel = R + G + B dot)	pixel
Pixel pitch	0.36375(H) x 0.36375 (V)	mm
Pixel configuration	R, G, B vertical stripe	
Display mode	Normally black	
Cell Outline Dimensions [Note1]	782(H) x 473(V) x 1.8(D)	mm
Mass	1.23	kg
Surface treatment [Note2] (Upper Polarizing film)	Anti glare(Haze:7.3%) Hard coating : 2H and more	
Surface treatment [Note2] (Lower Polarizing film)	plane Hard coating : —	

[Note1] Outline dimensions are shown in P22.

[Note2] With the protection film removed.

4 Cell Driving Specifications

4.1 Driving interface of Control PWB SHARP specifies[RUNTK4323TPZV] (▲A)

CN1 (Interface signals and +12V DC power supply) (Shown in Fig1)

Using connector : FI-RNE51SZ-HF (Japan Aviation Electronics Ind., Ltd.)

Matching connector : I-RE51HL, FI-RE51CL (Japan Aviation Electronics Ind., Ltd.)

Matching LVDS transmitter : THC63LVD1023 or equivalent device

Pin No.	Symbol	Function	Remark
1	GND		
2	Reserved	It is required to set non-connection(OPEN)	Pull up 3.3V
3	Reserved	It is required to set non-connection(OPEN)	Pull up 3.3V
4	Reserved	It is required to set non-connection(OPEN)	Pull up 3.3V
5	FRAME	Frame frequency setting 1:120Hz 0:100Hz [Note 1]	Pull down : (GND)
6	O/S set	O/S operation setting H:O/S ON, L:O/S OFF [Note 2]	Pull up 3.3V
7	SELLVDS	Select LVDS data order [Note 2,3]	Pull down : GND
8	Reserved	It is required to set non-connection(OPEN)	Pull down : (GND)
9	Reserved	It is required to set non-connection(OPEN)	Pull down : (GND)
10	Reserved	It is required to set non-connection(OPEN)	Pull down : (GND)
11	GND		
12	AIN0-	Aport (-)LVDS CH0 differential data input	
13	AIN0+	Aport (+)LVDS CH0 differential data input	
14	AIN1-	Aport (-)LVDS CH1 differential data input	
15	AIN1+	Aport (+)LVDS CH1 differential data input	
16	AIN2-	Aport (-)LVDS CH2 differential data input	
17	AIN2+	Aport (+)LVDS CH2 differential data input	
18	GND		
19	ACK-	Aport LVDS Clock signal(-)	
20	ACK+	Aport LVDS Clock signal(+)	
21	GND		
22	AIN3-	Aport (-)LVDS CH3 differential data input	
23	AIN3+	Aport (+)LVDS CH3 differential data input	
24	AIN4-	Aport (-)LVDS CH4 differential data input	
25	AIN4+	Aport (+)LVDS CH4 differential data input	
26	GND		
27	GND		
28	BIN0-	Bport (-)LVDS CH0 differential data input	
29	BIN0+	Bport (+)LVDS CH0 differential data input	
30	BIN1-	Bport (-)LVDS CH1 differential data input	
31	BIN1+	Bport (+)LVDS CH1 differential data input	
32	BIN2-	Bport (-)LVDS CH2 differential data input	
33	BIN2+	Bport (+)LVDS CH2 differential data input	
34	GND		
35	BCK-	Bport LVDS Clock signal(-)	
36	BCK+	Bport LVDS Clock signal(+)	
37	GND		
38	BIN3-	Bport (-)LVDS CH3 differential data input	
39	BIN3+	Bport (+)LVDS CH3 differential data input	
40	BIN4-	Bport (-)LVDS CH4 differential data input	
41	BIN4+	Bport (+)LVDS CH4 differential data input	
42	GND		
43	GND		
44	GND		
45	GND		
46	GND		
47	VCC	+12V Power Supply	
48	VCC	+12V Power Supply	
49	VCC	+12V Power Supply	
50	VCC	+12V Power Supply	
51	VCC	+12V Power Supply	

CN2 (Interface signals) (Shown in Fig1)

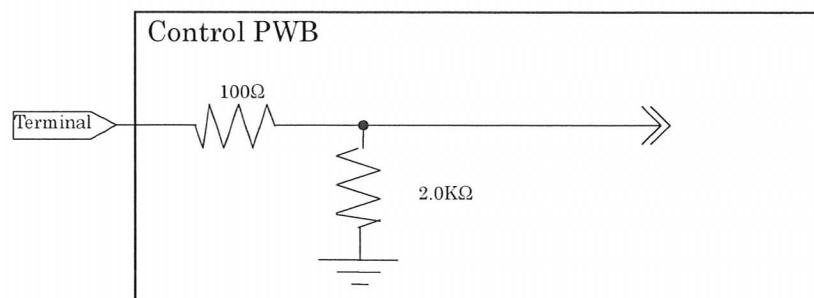
Using connector : FI-RNE41SZ-HF (Japan Aviation Electronics Ind., Ltd.)

Matching connector : FI-RE41HL, FI-RE41CL (Japan Aviation Electronics Ind., Ltd.)

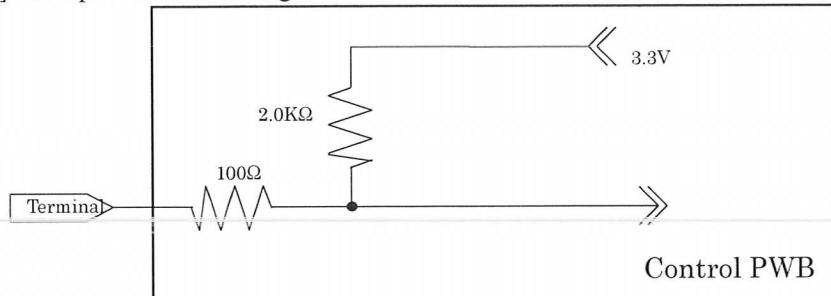
Pin No.	Symbol	Function	Remark
1	Reserved (VCC)	(+12V Power Supply)	
2	Reserved (VCC)	(+12V Power Supply)	
3	Reserved (VCC)	(+12V Power Supply)	
4	Reserved		
5	Reserved		
6	Reserved		
7	Reserved		
8	Reserved		
9	GND		
10	CIN0-	Cport (-)LVDS CH0 differential data input	
11	CIN0+	Cport (+)LVDS CH0 differential data input	
12	CIN1-	Cport (-)LVDS CH1 differential data input	
13	CIN1+	Cport (+)LVDS CH1 differential data input	
14	CIN2-	Cport (-)LVDS CH2 differential data input	
15	CIN2+	Cport (+)LVDS CH2 differential data input	
16	GND		
17	CCK-	Cport LVDS Clock signal(-)	
18	CCK+	Cport LVDS Clock signal(+)	
19	GND		
20	CIN3-	Cport (-)LVDS CH3 differential data input	
21	CIN3+	Cport (+)LVDS CH3 differential data input	
22	CIN4-	Cport (-)LVDS CH4 differential data input	
23	CIN4+	Cport (+)LVDS CH4 differential data input	
24	GND		
25	GND		
26	DIN0-	Dport (-)LVDS CH0 differential data input	
27	DIN0+	Dport (+)LVDS CH0 differential data input	
28	DIN1-	Dport (-)LVDS CH1 differential data input	
29	DIN1+	Dport (+)LVDS CH1 differential data input	
30	DIN2-	Dport (-)LVDS CH2 differential data input	
31	DIN2+	Dport (+)LVDS CH2 differential data input	
32	GND		
33	DCK-	Dport LVDS Clock signal(-)	
34	DCK+	Dport LVDS Clock signal(+)	
35	GND		
36	DIN3-	Dport (-)LVDS CH3 differential data input	
37	DIN3+	Dport (+)LVDS CH3 differential data input	
38	DIN4-	Dport (-)LVDS CH4 differential data input	
39	DIN4+	Dport (+)LVDS CH4 differential data input	
40	GND		
41	GND		

[Note] GND of parts driven a liquid crystal panel drive has connected with a module chassis.

[Note 1]The equivalent circuit figure of the terminal



[Note 2]The equivalent circuit figure of the terminal

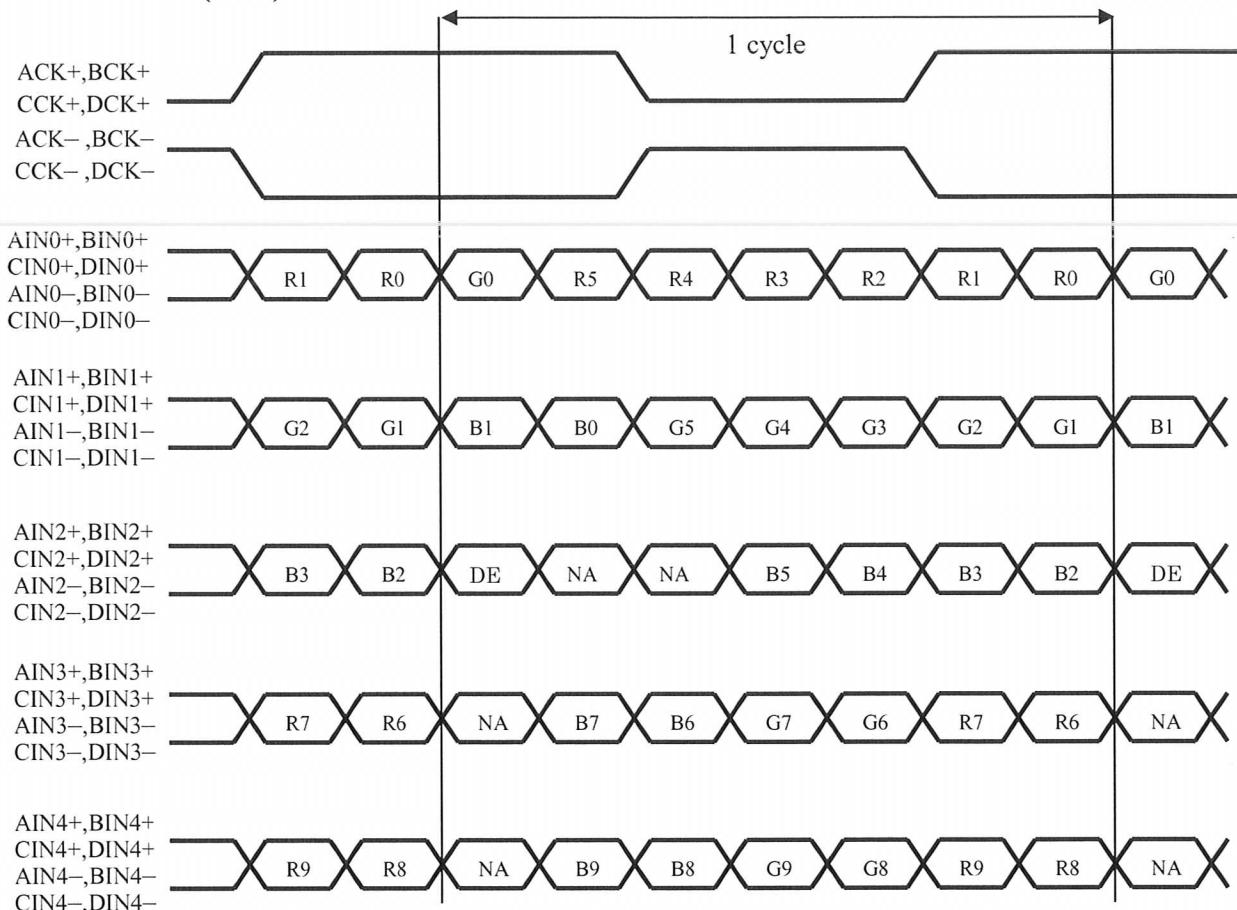
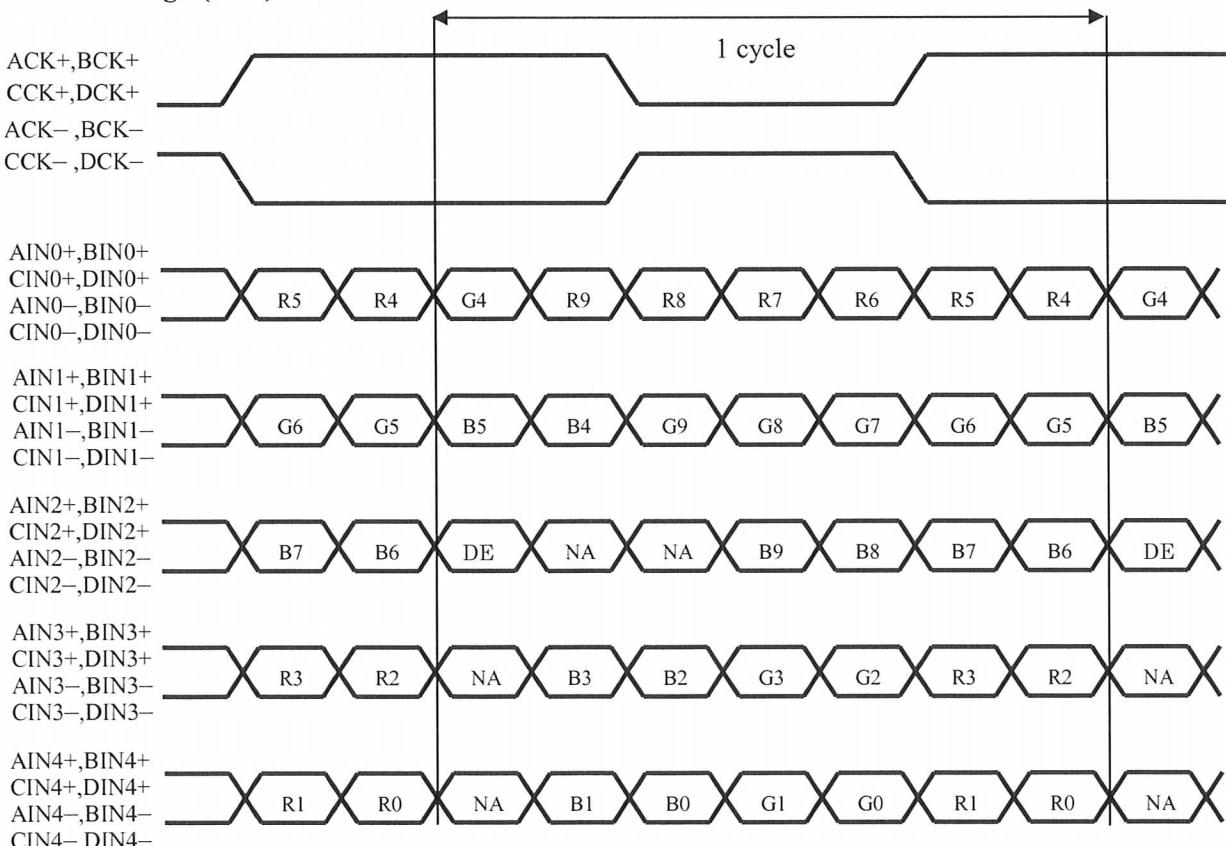


[Note 3] LVDS Data order

SELLVDS		
Data	L(GND) or Open [VESA]	H(3.3V) [JEIDA]
TA0	R0(LSB)	R4
TA1	R1	R5
TA2	R2	R6
TA3	R3	R7
TA4	R4	R8
TA5	R5	R9(MSB)
TA6	G0(LSB)	G4
TB0	G1	G5
TB1	G2	G6
TB2	G3	G7
TB3	G4	G8
TB4	G5	G9(MSB)
TB5	B0(LSB)	B4
TB6	B1	B5
TC0	B2	B6
TC1	B3	B7
TC2	B4	B8
TC3	B5	B9(MSB)
TC4	NA	NA
TC5	NA	NA
TC6	DE(*)	DE(*)
TD0	R6	R2
TD1	R7	R3
TD2	G6	G2
TD3	G7	G3
TD4	B6	B2
TD5	B7	B3
TD6	N/A	N/A
TE0	R8	R0(LSB)
TE1	R9(MSB)	R1
TE2	G8	G0(LSB)
TE3	G9(MSB)	G1
TE4	B8	B0(LSB)
TE5	B9(MSB)	B1
TE6	N/A	N/A

NA: Not Available

(*)Since the display position is prescribed by the rise of DE(Display Enable)signal, please do not fix DE signal during operation at "High".

SELLVDS= Low (GND)**SELLVDS= High (3.3V) or OPEN**

DE: Display Enable, NA: Not Available (Fixed Low)

- Interface block diagram

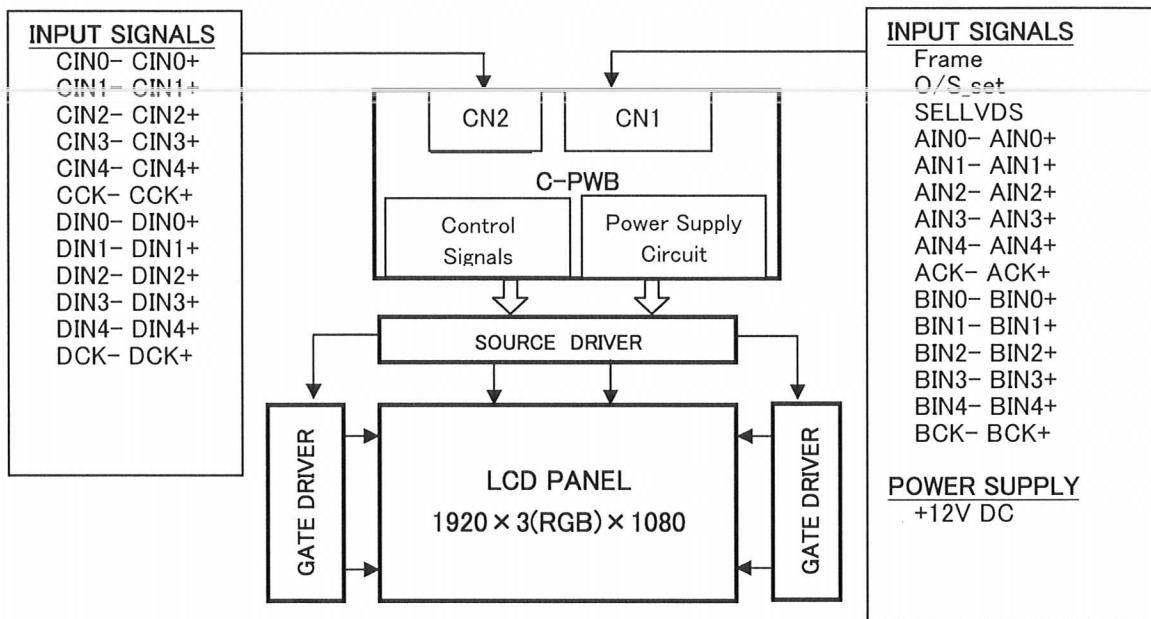


Fig.1 Interface block diagram

4.2 Vcom Adjusting interface of Control PWB SHARP specifies[RUNTK4323TPZV]

CN2(Interface Vcom Adjusting) [note1]

Using Via Hole : 1.5mm Pitch (ϕ 0.7mm)

Mating connector : (housing)3P-SZN, (contact)SZN-002T-P0.7K (JST Co.,Ltd.)

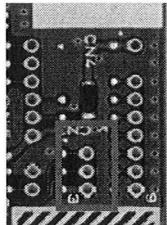
Communication method : I2C

Pin No.	Symbol	Function	Remark
1	SDA	I2C DATA	Pull up 3.3V[Note2]
2	SCL	I2C CLK	Pull up 3.3V[Note2]
3	GND		

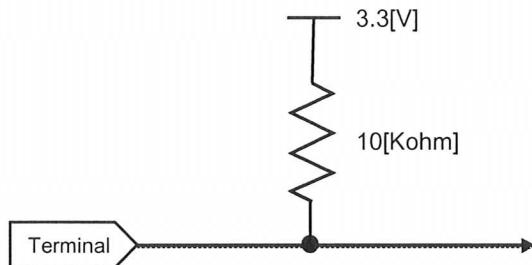
Refer to specifications of ISL24837 for the I2C command of Vcom adjustment.

[Note1]Interface

[Note2] The equivalent circuit figure of the terminal



PinNo	Symbol
1	SDA
2	SCL
3	GND



4.3 Absolute Maximum Ratings

Parameter	Symbol	Condition	Ratings	Unit	Remark
Input voltage (for Control)	V _I	T _a =25 °C	-0.3 ~ 3.6	V	[Note 1]
12V supply voltage (for Control)	V _{CC}	T _a =25 °C	0 ~ +14	V	
Storage temperature	T _{stg}	-	-25 ~ +60	°C	[Note 2]
Operation temperature (Ambient)	T _{opa}	-	0 ~ +50	°C	

[Note 1] SELLVDS FRAME, O/S_set,

[Note 2] Humidity 95%RH Max.(Ta≤40°C)

Maximum wet-bulb temperature at 39 °C or less.(Ta>40°C)

No condensation.

4.4 Electrical Characteristics of input signals

Ta=25 °C

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
+12V supply voltage	Supply voltage	Vcc	11.4	12	V	[Note 1]
	Current dissipation	Icc	-	0.7	A	[Note 2]
	Inrush current	IRUSH	-	6	A	[Note 7]
Permissible input ripple voltage	V _{RP}	-	-	100	mV _{P-P}	Vcc = +12.0V
Differential input threshold voltage	High	V _{TH}	-	100	mV	V _{CM} = +1.2V [Note 6]
	Low	V _{TL}	-100	-	mV	
Input Low voltage	V _{IL}	0	-	1.0	V	[Note 3]
Input High voltage	V _{IH}	2.3	3.3	3.6	V	
Input leak current (Low)	I _{IL1}	-	-	400	μA	V _I = 0V [Note 4]
	I _{IL2}	-	-	40	μA	V _I = 0V [Note 5]
Input leak current (High)	I _{IH1}	-	-	40	μA	V _I = 3.3V [Note 4]
	I _{IH2}	-	-	400	μA	V _I = 3.3V [Note 5]
Terminal resistor	R _T	-	100	-	Ω	Differential input

[Note]V_{CM}: Common mode voltage of LVDS driver.

[Note 1]

Input voltage sequences

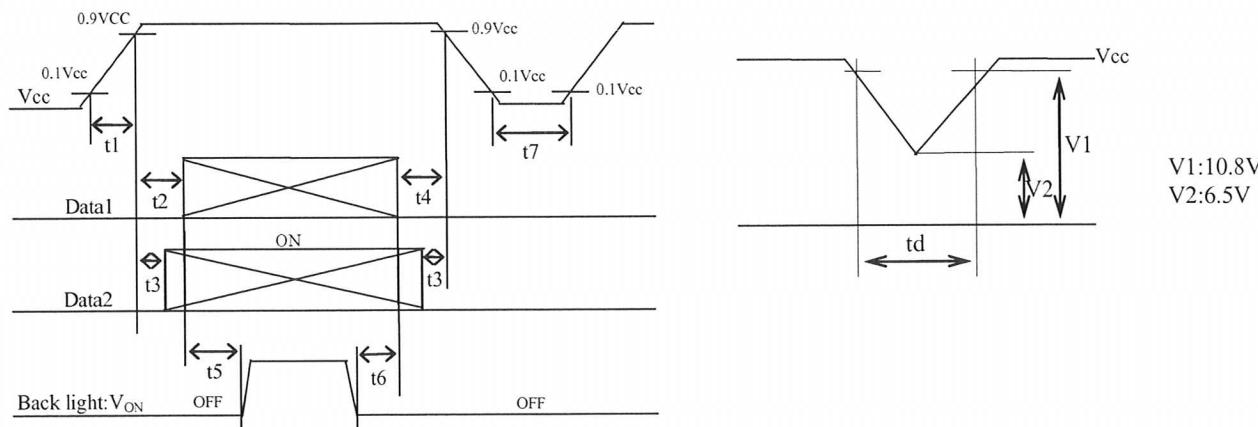
$$\begin{aligned} 0 < t_1 &\leq 20\text{ms} \\ 10 < t_2 &\leq 50\text{ms} \\ 10 < t_3 &\leq 50\text{ms} \\ 0 < t_4 &\leq 1\text{s} \\ t_5 &\geq 1000 \text{ ms} \\ t_6 &\geq 0 \\ t_7 &\geq 300\text{ms} \end{aligned}$$

Dip conditions for supply voltage

a) $6.5V \leq V_{cc} < 10.8V$
 $t_d \leq 10\text{ms}$

b) $V_{cc} < 6.5V$

Dip conditions for supply voltage is based on input voltage sequence.



* Data1: ACK±, AIN0±, AIN1±, AIN2±, AIN3±, AIN4±, BCK±, BIN0±, BIN1±, BIN2±, BIN3±, BIN4± CCK±, CIN0±, CIN1±, CIN2±, CIN3±, CIN4±, DCK±, DIN0±, DIN1±, DIN2±, DIN3±, DIN4±

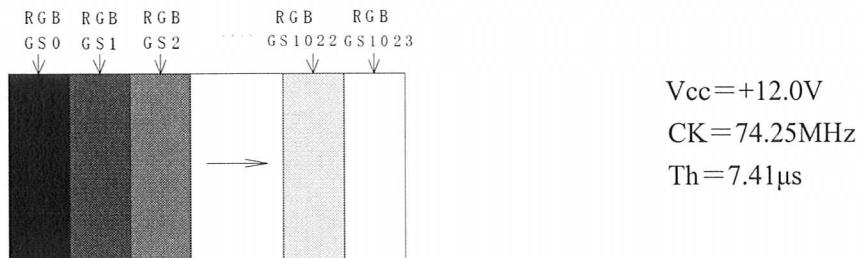
* V_{CM} voltage pursues the sequence mentioned above

* Data2: SELLVDS, FRAME, O/S_SET

[Note] About the relation between data input and back light lighting, please base on the above-mentioned input sequence. When back light is switched on before panel operation or after a panel operation stop, it may not display normally. But this phenomenon is not based on change of an incoming signal, and does not give damage to a liquid crystal display.

[Note 2] Typical current situation: 1024 gray-bar patterns. ($V_{CC} = +12.0V$)

The explanation of RGB gray scale is seen in section 8.



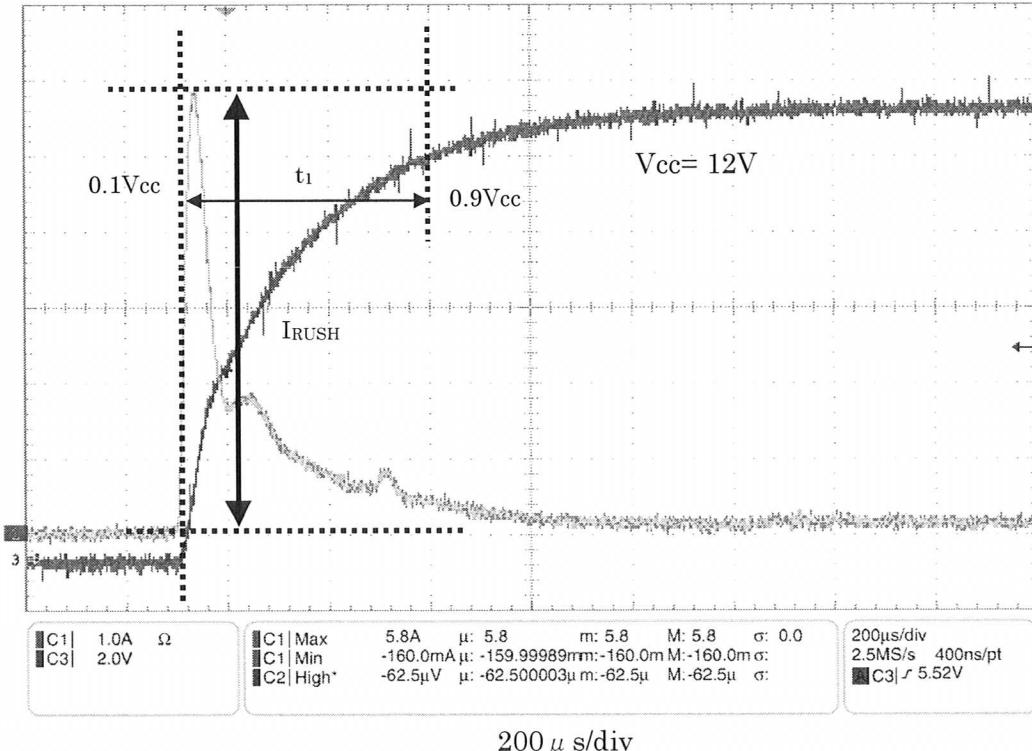
[Note 3] SELLVDS, FRAME, O/S_SET

[Note 4] O/S_SET, SELLVDS

[Note 5] FRAME

[Note 6] ACK±, AIN0±, AIN1±, AIN2±, AIN3±, AIN4±, BCK±, BIN0±, BIN1±, BIN2±, BIN3±, BIN4±, CCK±, CIN0±, CIN1±, CIN2±, CIN3±, CIN4±, DCK±, DIN0±, DIN1±, DIN2±, DIN3±, DIN4±

[Note 7] V_{CC} 12V inrush current waveform (This figure is $I_{RUSH} : t_1 = 500 \mu s$)



4.5 Timing characteristics of input signals for C-PWB

Timing diagrams of input signal are shown in Fig.2.

Parameter		Symbol	Min.	Typ.	Max.	Unit	Remark
Clock	Frequency	1/Tc	69	74.25	76	MHz	
Data enable signal	Horizontal period	TH	542	550	600	clock	
			7.3	7.41	8.1	μs	
	Horizontal period (High)	THd	480	480	480	clock	
	Vertical period	TV	1096	1350	1125	1400	line
			88.2	100	120	123.10	Hz
	Vertical period (High)	TVd	1080	1080	1080	line	

[Note]-When vertical period is very long, flicker and etc. may occur.

-Please turn off the module after it shows the black screen.

-Please make sure that length of vertical period should become of an integral multiple of horizontal length of period. Otherwise, the screen may not display properly.

-As for your final setting of driving timing, we will conduct operation check test at our side, please inform your final setting.

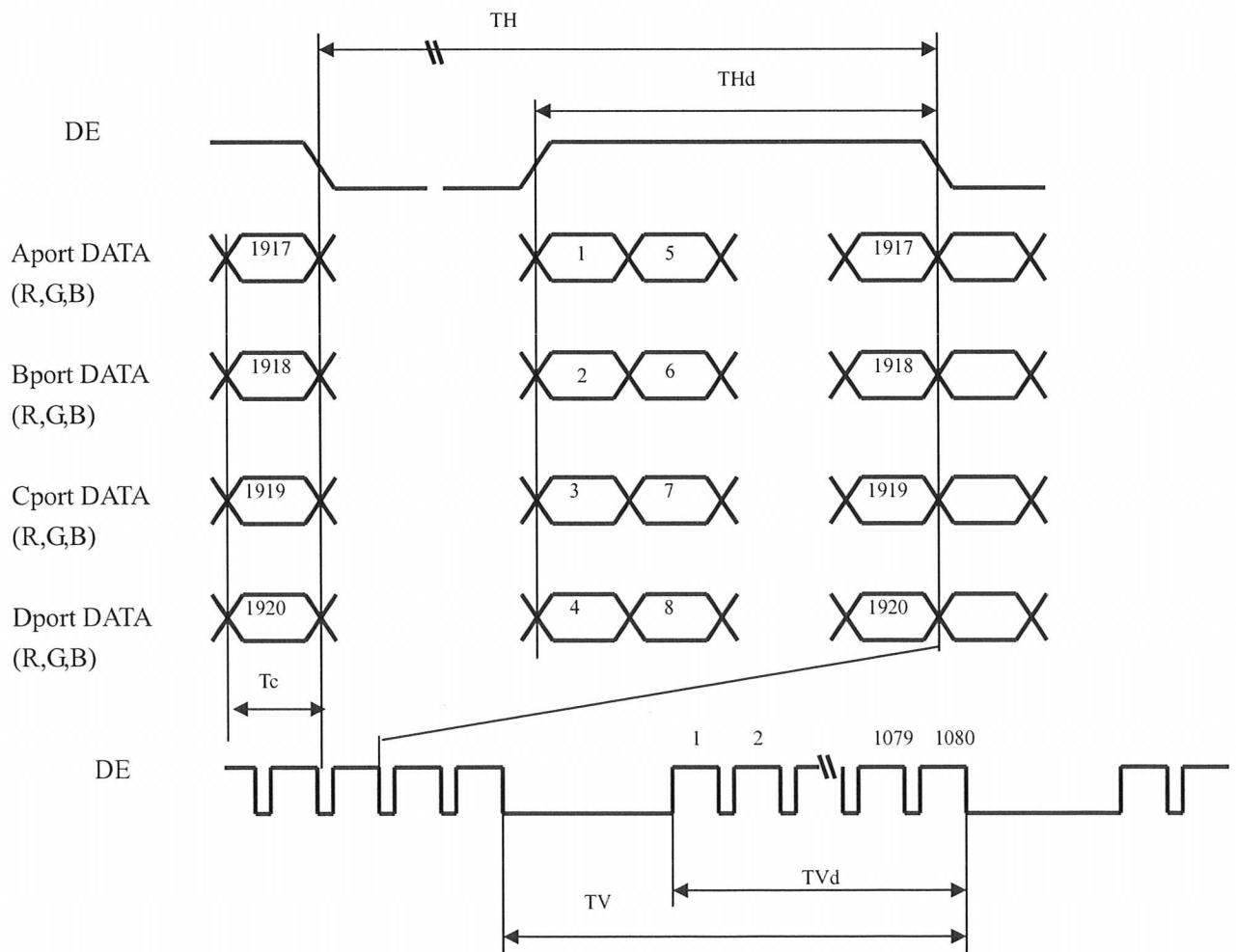
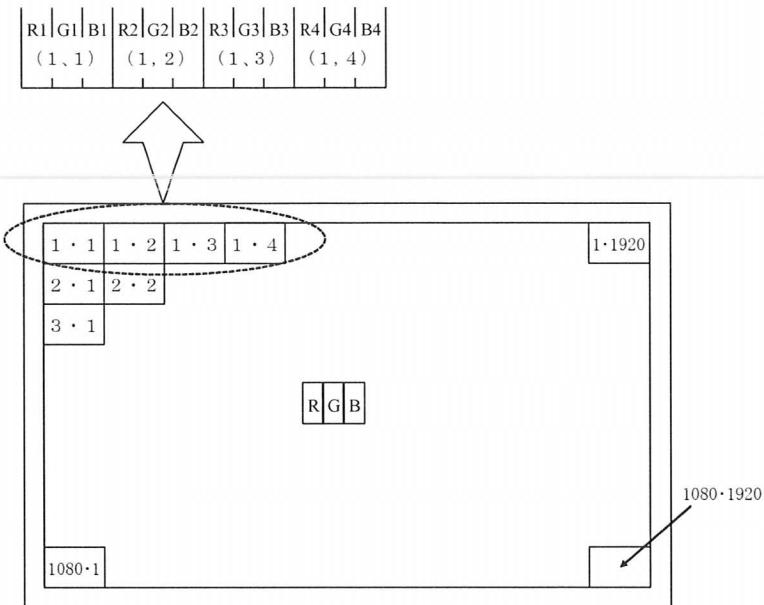


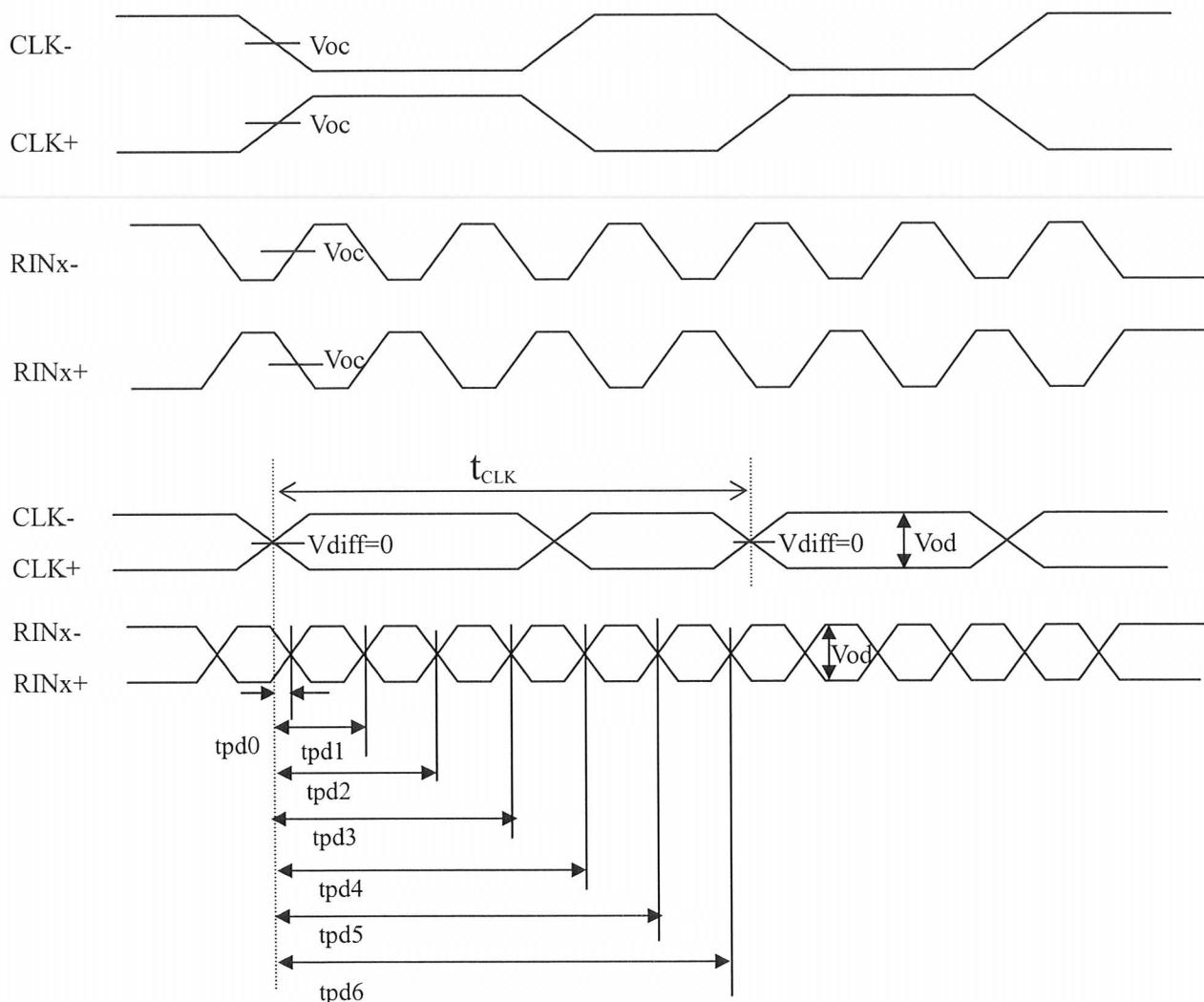
Fig.2.Timing characteristics of input signal

4.6 Input data signal and display position on the screen



Display position of Dat (V,H)

4.7 LVDS signal characteristics



The item	Symbol	min.	typ.	max.	unit
Differential voltage	V_{OD}	200	400	600	mV
Common mode voltage	V_{OC}	$V_{OD}/2$	1200	$2400 - V_{OD}/2$	
LVDS clock period	t_{CLK}	12.35	13.50	13.69	ns
Data position	Delay time, CLK rising edge to serial bit position 0	$tpd0$	-0.25	0	
	Delay time, CLK rising edge to serial bit position 1	$tpd1$	$1*t_{CLK}/7 - 0.25$	$1*t_{CLK}/7$	
	Delay time, CLK rising edge to serial bit position 2	$tpd2$	$2*t_{CLK}/7 - 0.25$	$2*t_{CLK}/7$	
	Delay time, CLK rising edge to serial bit position 3	$tpd3$	$3*t_{CLK}/7 - 0.25$	$3*t_{CLK}/7$	
	Delay time, CLK rising edge to serial bit position 4	$tpd4$	$4*t_{CLK}/7 - 0.25$	$4*t_{CLK}/7$	
	Delay time, CLK rising edge to serial bit position 5	$tpd5$	$5*t_{CLK}/7 - 0.25$	$5*t_{CLK}/7$	
	Delay time, CLK rising edge to serial bit position 6	$tpd6$	$6*t_{CLK}/7 - 0.25$	$6*t_{CLK}/7$	

5 Optical Specifications

5.1 Input Signal, Basic Display Colors and Gray Scale of Each Color

Colors & Gray scale	Data signal																														
	Gray Scale	R0	R1	R2	R3	R4	R5	R6	R7	R8	R9	G0	G1	G2	G3	G4	G5	G6	G7	G8	G9	B0	B1	B2	B3	B4	B5	B6	B7	B8	B9
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
Basic Color	Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Blue	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	
	Green	-	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	
	Cyan	-	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
	Red	-	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Magenta	-	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	
	Yellow	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	
	White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Gray Scale of Red	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	↑	GS1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Darker	GS2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	↓	↓				↓				↓				↓				↓				↓				↓					
	Brighter	GS1021	1	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	↓	GS1022	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Red	GS1023	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
Gray Scale of Green	↑	GS1	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Darker	GS2	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	↓	↓				↓				↓				↓				↓				↓				↓					
	Brighter	GS1021	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
	↓	GS1022	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
	Green	GS1023	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	↑	GS1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	
Gray Scale of Blue	Darker	GS2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0
	↓	↓				↓				↓				↓				↓				↓				↓					
	Brighter	GS1021	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1	1	1	1
	↓	GS1022	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
	Blue	GS1023	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	

0: Low level voltage,

1: High level voltage.

Each basic color can be displayed in 1024 gray scales from 10 bits data signals. According to the combination of total 30 bits data signals, one billion-color display can be achieved on the screen.

6 Optical Specifications

6.1 Optical characteristics (Reference value)

Ta=25°C, Vcc=12.0V, Timing:120Hz(typ. value)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Viewing angle range	Horizontal θ21 θ22	CR≥10	70	88	-	Deg.	[Note1,4]
	Vertical θ11 θ12		70	88	-	Deg.	
Contrast ratio	CRn	θ=0 deg.	3600	4500	-	-	[Note2,4]
Response time	τDRV			4	8	ms	[Note3,4,5]
Transmittance	T	θ=0 deg.	-	4.37	-	%	
Luminance	White x y		Typ.-0.03	0.280	Typ.+0.03	-	[Note4]
	Red x y	θ=0 deg.	Typ.-0.03	0.640	Typ.+0.03	-	
	Green x y		Typ.-0.03	0.345	Typ.+0.03	-	
	Blue x y	θ=0 deg.	Typ.-0.03	0.300	Typ.+0.03	-	
	White		345	430	-	cd/m ²	
Luminance uniformity	White	δw	-	-	1.25		[Note 6]

-Measurement condition : Open-Cell sample set on the SHARP standard back light system.

-The measurement shall be executed 60 minutes after lighting at rating.

[Note]The optical characteristics are measured using the following equipment.

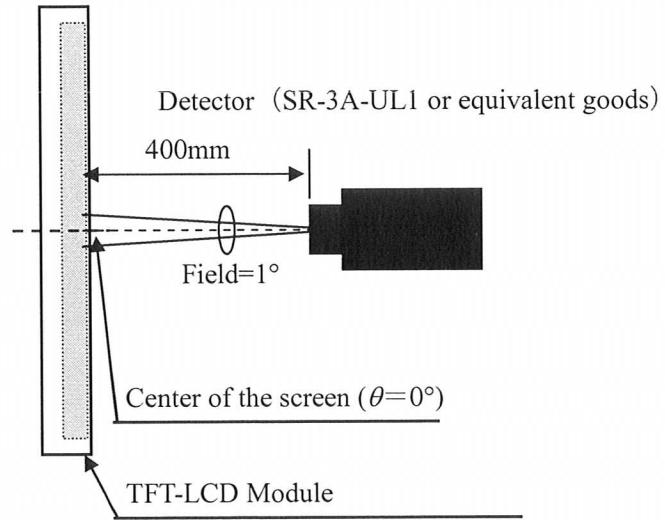
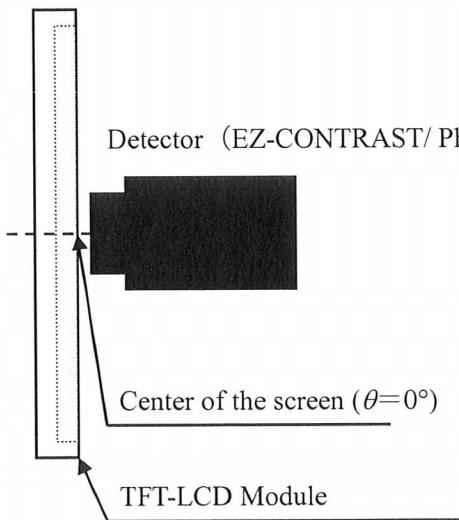


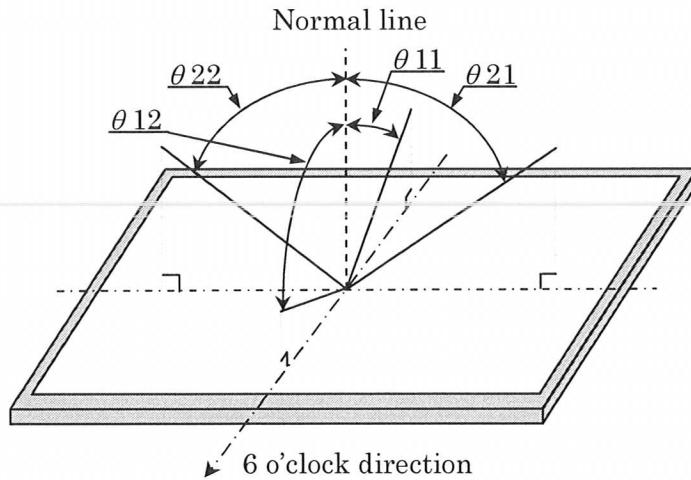
Fig.3-1 Measurement of viewing angle range and Response time.

Viewing angle range: EZ-CONTRAST

Response time: Photodiode

Fig.3-2 Measurement of Contrast, Luminance, Chromaticity.

[Note 1] Definitions of viewing angle range :



[Note 2] Definition of contrast ratio :

The contrast ratio is defined as the following.

$$\text{Contrast Ratio} = \frac{\text{Luminance (brightness) with all pixels white}}{\text{Luminance (brightness) with all pixels black}}$$

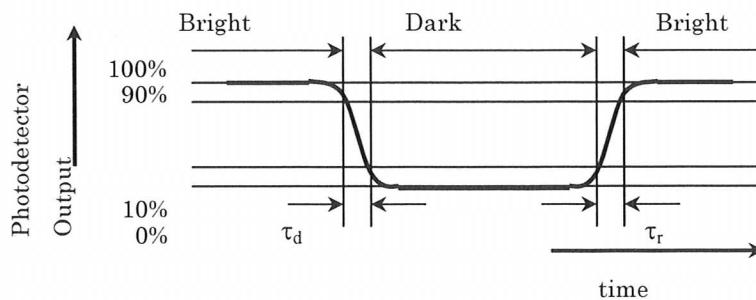
[Note 3] Definition of response time

The response time (τ_d and τ_r) is defined as the following figure and shall be measured by switching the input signal for “any level of gray (0%, 25%, 50%, 75% and 100%)” and “any level of gray (0%, 25%, 50%, 75% and 100%)”.

	0%	25%	50%	75%	100%
0%		tr:0%-25%	tr:0%-50%	tr:0%-75%	tr:0%-100%
25%	td: 25%-0%		tr: 25%-50%	tr: 25%-75%	tr: 25%-100%
50%	td: 50%-0%	td: 50%-25%		tr: 50%-75%	tr: 50%-100%
75%	td: 75%-0%	td: 75%-25%	td: 75%-50%		tr: 75%-100%
100%	td: 100%-0%	td: 100%-25%	td: 100%-50%	td: 100%-75%	

t*:x-y...response time from level of gray(x) to level of gray(y)

$$\tau_r = \Sigma(\text{tr}:x-y)/10, \quad \tau_d = \Sigma(\text{td}:x-y)/10$$



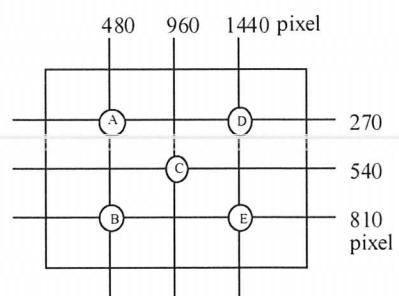
[Note 4] This shall be measured at center of the screen.

[Note 5] This value is valid when O/S driving is used at typical input time value.

[Note 6]Definition of white uniformity ;

White uniformity is defined as the following with five measurements. (A~E)

$$\delta_w = \frac{\text{Maximum luminance of five points (brightness)}}{\text{Minimum luminance of five points (brightness)}}$$



7 Shipping and Packing

7.1 Packing form

- | | |
|---|-----------------------------|
| a) Piling number of cell boxes | : 14 cell box/1 palette |
| b) Packing quantity in one cell box | : 10 pcs |
| c) Carton size | : 1165(W) x 965(D) x 858(H) |
| d) Total mass of one carton filled with full cell | : 245.6 kg |

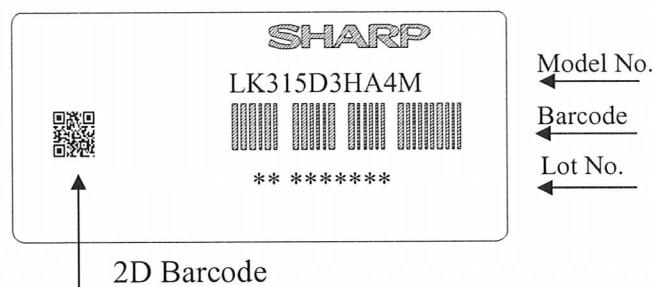
7.2 Label

a) Cell Label

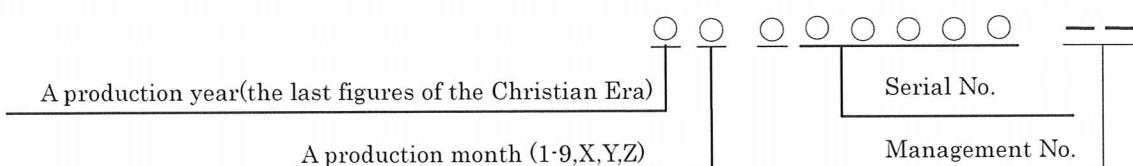
This label is stuck on the protection film of front polarizer.

(Please trace the Cell lot number after the film is peeled off..)

[LK315D3HA4M] JAPAN PRODUCTION



How to express Lot No.



Identification Code

K: Kameyama Plant.	F: D.ID
L: Kameyama Tec. Kameyama Fab.	H: INNOLUX
J: Kameyama Tec. Yaita Fab.	Y: TPV
S: SHM	V: TOT
N: NSEC	
P: SMPL	
G: SMM	
X: SEMEX	
A or B: JABIL	

b) Packing Label

This Label is stuck on the packing case(cell box) and carton.

[LK315D3HA4M] JAPAN PRODUCTION

b)-1 Open Cell box

b)-2 Carton

社内品番 :	LK315D3HA4M	(①)
Bar code		
Lot No. • (1T) * * * *. *. * * (②)		
Bar code		10 p c s (③)
Quantity :	(Q)	
Bar code		
ユーザ品番		
Bar code		
シャープ物流用ラベルです。		

社内品番 :	LK315D3HA4M	(①)
Bar code		
Lot No. • (1T) * * * *. *. * * (②)		
Bar code		140 p c s (③)
Quantity :	(Q)	
Bar code		
ユーザ品番		
Bar code		
シャープ物流用ラベルです。		

① Management No.

② Lot No. (Date)

③ Quantity

8 Carton storage condition.

Temperature 0°C to 40°C

Humidity 95%RH or less

Reference condition : 20°C to 35°C, 85%RH or less (summer)

: 5°C to 15°C, 85%RH or less (winter)

· the total storage time (40°C, 95%RH) : 240H or less

Sunlight Be sure to shelter a product from the direct sunlight.

Atmosphere Harmful gas, such as acid and alkali which bites electronic components and/or wires must not be detected.

Notes Be sure to put cartons on palette or base, don't put it on floor, and store them with removing from wall

Please take care of ventilation in storehouse and around cartons, and control changing temperature is within limits of natural environment

Storage life Six months

9 Reliability

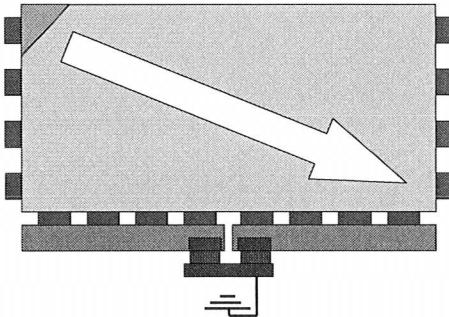
Reliability test item

No.	Test item	Condition	
1	High temperature storage test	Ta = 60°C	240h
2	Low temperature storage test	Ta = -25°C	240h
3	High temperature and high humidity operation test	Ta = 40°C ; 95%RH (No condensation)	240h
4	High temperature operation test	Ta = 50°C	240h
5	Low temperature operation test	Ta = 0°C	240h

Above tests are executed under the CCFL module conditions.

10 Precautions

- a) Because the cell is weak to static electricity, please do not touch the terminal.
- b) Since the polarizer is easily damaged, pay attention not to scratch it.
- c) Since long contact with water may cause discoloration or spots, wipe off water drop immediately.
- d) When the polarizer is soiled, wipe it with absorbent cotton or other soft cloth.
- e) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface. Handle with care.
- f) Precautions of peeling off the protection film.
 - Be sure to peel off slowly (recommended more than 7sec) and constant speed.
 - Peeling direction shows Fig.
 - Be sure to ground person with adequate methods such as the anti-static wrist band.
 - Be sure to ground S-PWB while peeling of the protection film.
 - Ionized air should be blown over during peeling action.
 - The protection film must not touch drivers and S-PWBs.
 - If adhesive may remain on the polarizer after the protection film peeling off,
please remove with isopropyl-alcohol.



- g) Since the Open Cell consists of TFT and electronic circuits with CMOS-ICs, which are very weak to electrostatic discharges, persons who are handling the Open Cell should be grounded through adequate methods such as the anti-static wrist band. Connector pins should not be touched directly with bare hands.
 - Reference : Process control standard of sharp

Item	Management standard value and performance standard
1 Anti-static mat (floor)	1 to 50 [M ohm]
2 Anti-static mat (shelf, desk)	1 to 100 [M ohm]
3 Ionizer	<ul style="list-style-type: none"> • Attenuate from $\pm 1000V$ to $\pm 100V$ within 2 sec • Ion balance $\pm 50V$
4 Anti-static wrist band	0.8 to 10 [M ohm]
5 Anti-static wrist band entry and ground resistance	Below 1000 [ohm]
6 Temperature	22 to 26 [°C]
7 Humidity	60 to 70 [%RH]

- h) The Open Cell has some PWBs, take care to keep them from any stress or pressure when handling or installing the Open Cell, otherwise some of electronic parts on the PWBs may be damaged.
- i) Be sure to turn off the power supply when inserting or disconnecting the cable.
- j) Be sure to design the module and cabinet so that the Open Cell can be installed without any extra stress such as warp or twist.
- k) When handling the Open Cell and assembling them into module and cabinets, please be noted that long-term storage in the environment of oxidization or deoxidization gas and the use of such materials as reagent, solvent, adhesive, resin, etc. which generate these gasses, may cause corrosion and discoloration of the Open Cell.
- l) Applying too much force and stress to PWB and driver may cause a malfunction electrically and mechanically.
- m) The Open Cell has high frequency circuits. Sufficient suppression to EMI should be done by system manufacturers.
- n) Please be careful since image retention may occur when a fixed pattern is displayed for a long time.
- o) The chemical compound, which causes the destruction of ozone layer, is not used.
- p) This Open Cell is corresponded to RoHS. "R.C." label on the side of palette shows it.
- q) When any question or issue occurs, it shall be solved by mutual discussion.

